

## Rail-to-rail input/output 20 MHz GBP operational amplifiers

### Features

- Low input offset voltage: 1.5 mV max
- Rail-to-rail input and output
- Wide bandwidth 20 MHz, stable for gain  $\geq 3$
- Low power consumption: 1.1 mA maximum
- High output current: 35 mA
- Operating from 2.5 V to 5.5 V
- Low input bias current, 1 pA typ
- ESD internal protection  $\geq 5$  kV
- Latch-up immunity

### Applications

- Battery-powered applications
- Portable devices
- Signal conditioning
- Active filtering
- Medical instrumentation
- Automotive

### Description

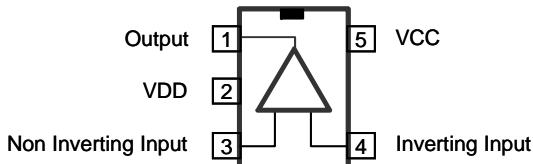
The TSV991/2/4 family of single, dual and quad operational amplifiers offers low voltage operation and rail-to-rail input and output.

This family features an excellent speed/power consumption ratio, offering a 20 MHz gain-bandwidth, stable for gain above 3 (100 pF capacitive load), while consuming only 1.1 mA max at 5 V supply voltage. It also features an ultra-low input bias current.

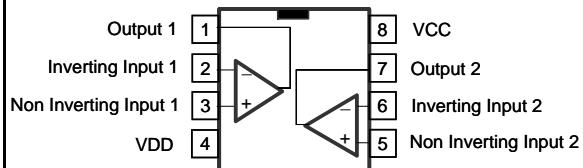
These characteristics make the TSV991/2/4 family ideal for sensor interfaces, battery-supplied and portable applications, as well as active filtering.

#### Pin connections (top view)

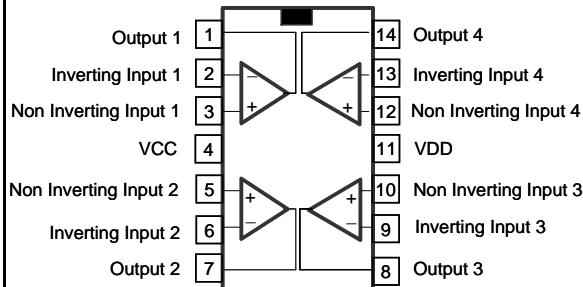
SOT23-5



MiniSO-8, SO-8



SO-14, TSSOP14



# 1 Absolute maximum ratings and operating conditions

**Table 1. Absolute maximum ratings (AMR)**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply voltage <sup>(1)</sup>	6	V
$V_{id}$	Differential input voltage <sup>(2)</sup>	$\pm V_{CC}$	V
$V_{in}$	Input voltage <sup>(3)</sup>	$V_{DD}-0.2$ to $V_{CC}+0.2$	V
$T_{stg}$	Storage temperature	-65 to +150	°C
$R_{thja}$	Thermal resistance junction to ambient <sup>(4) (5)</sup> SOT23-5 SO-8 MiniSO-8 SO-14 TSSOP14	250 125 190 103 100	°C/W
$R_{thjc}$	Thermal resistance junction to case SOT23-5 SO-8 MiniSO-8 SO-14 TSSOP14	81 40 39 31 32	°C/W
$T_j$	Maximum junction temperature	150	°C
ESD	HBM: human body model <sup>(6)</sup>	5	kV
	MM: machine model <sup>(7)</sup>	400	V
	CDM: charged device model <sup>(8)</sup> SOT23-5, SO-8, MiniSO-8 TSSOP14 SO-14	1500 750 500	V
	Latch-up immunity	200	mA

1. Value with respect to  $V_{DD}$  pin.
2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
3.  $V_{CC}-V_{in}$  must not exceed 6V.
4. Short-circuits can cause excessive heating and destructive dissipation.
5.  $R_{th}$  are typical values.
6. Human body model: 100pF discharged through a 1.5kΩ resistor between two pins of the device, done for all couples of pin combinations with other pins floating.
7. Machine model: 200pF is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5Ω), done for all couples of pin combinations with other pins floating.
8. Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to the ground.

**Table 2. Operating conditions**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply voltage	2.5 to 5.5	V
$V_{icm}$	Common mode input voltage range	$V_{DD} -0.1$ to $V_{CC} +0.1$	V
$T_{oper}$	Operating free air temperature range	-40 to +125	°C

## 2 Electrical characteristics

**Table 3. Electrical characteristics at  $V_{CC} = +2.5V$ ,  $V_{DD} = 0V$ ,  $V_{icm} = V_{CC}/2$ , with  $R_L$  connected to  $V_{CC}/2$ , full temperature range (unless otherwise specified)<sup>(1)</sup>**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>DC performance</b>						
$V_{io}$	Offset voltage TSV99x	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	0.1	4.5	mV
	TSV99xA	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	-	1.5	
$DV_{io}$	Input offset voltage drift		-	2	-	$\mu V/^\circ C$
$I_{io}$	Input offset current <sup>(2)</sup> ( $V_{out} = V_{CC}/2$ )	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	1	10	pA
$I_{ib}$	Input bias current <sup>(2)</sup> ( $V_{out} = V_{CC}/2$ )	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	1	10	
CMR	Common mode rejection ratio $20 \log (\Delta V_{ic}/\Delta V_{io})$	0V to 2.5V, $V_{out} = 1.25V$	58	75	-	dB
$A_{vd}$	Large signal voltage gain	$R_L = 10k\Omega$ $V_{out} = 0.5V$ to $2V$ , $T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	80 75	89	-	dB
$V_{CC}-V_{OH}$	High level output voltage	$R_L = 10k\Omega$ $R_L = 600\Omega$		15 45	40 150	mV
$V_{OL}$	Low level output voltage	$R_L = 10k\Omega$ $R_L = 600\Omega$	-	15 45	40 150	mV
$I_{out}$	$I_{sink}$	$V_o = 2.5V$ , $T = 25^\circ C$ $T_{min} < T_{amb} < T_{max}$	18 16	32	-	mA
	$I_{source}$	$V_o = 0V$ , $T = 25^\circ C$ $T_{min} < T_{amb} < T_{max}$	18 16	35	-	
$I_{cc}$	Supply current (per operator)	No load, $V_{out}=V_{CC}/2$	-	0.78	1.1	mA
<b>AC performance</b>						
GBP	Gain bandwidth product	$R_L = 2k\Omega$ , $C_L = 100pF$ , $f = 100kHz$ , $T = 25^\circ C$	-	20	-	MHz
$\phi m$	Phase margin	$R_L = 2k\Omega$ , $C_L = 100pF$ , $G=5$ , $f=100kHz$ , $T=25^\circ C$	-	60	-	Degrees
$G_m$	Gain margin	$R_L = 2k\Omega$ , $C_L = 100pF$ , $\phi m = 40^\circ$ , $T = 25^\circ C$	-	2.5	-	dB
SR	Slew rate	$R_L = 2k\Omega$ , $C_L = 100pF$ , $T = 25^\circ C$	-	10	-	V/ $\mu s$
$e_n$	Equivalent input noise voltage	$f = 10kHz$ , $T = 25^\circ C$	-	21	-	$\frac{nV}{\sqrt{Hz}}$
THD+ $e_n$	Total harmonic distortion	$G=1$ , $f=1kHz$ , $R_L = 2k\Omega$ , $Bw = 22kHz$ , $V_{icm} = (V_{CC}+1)/2$ , $V_{out} = 1.1V_{pp}$ , $T = 25^\circ C$	-	0.0017	-	%

1. All parameter limits at temperatures other than  $25^\circ C$  are guaranteed by correlation.

2. Guaranteed by design.

**Table 4. Electrical characteristics at  $V_{CC} = +3.3V$ ,  $V_{DD} = 0V$ ,  $V_{icm} = V_{CC}/2$ , with  $R_L$  connected to  $V_{CC}/2$ , full temperature range (unless otherwise specified)<sup>(1)</sup>**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>DC performance</b>						
$V_{io}$	Offset voltage TSV99x	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	0.1	4.5	mV
	TSV99xA	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	-	1.5	
$DV_{io}$	Input offset voltage drift		-	2	-	$\mu V/^\circ C$
$I_{io}$	Input offset current <sup>(2)</sup> ( $V_{out} = V_{CC}/2$ )	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	1	10	pA
$I_{ib}$	Input bias current <sup>(2)</sup> ( $V_{out} = V_{CC}/2$ )	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	1	10	
CMR	Common mode rejection ratio $20 \log (\Delta V_{ic}/\Delta V_{io})$	0V to 3.3V, $V_{out} = 1.65V$	60	78	-	dB
$A_{vd}$	Large signal voltage gain	$R_L = 10k\Omega$ , $V_{out} = 0.5V$ to $2.8V$ , $T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	80 75	90 -	-	dB
$V_{CC}-V_{OH}$	High level output voltage	$R_L = 10k\Omega$ $R_L = 600\Omega$		15 45	40 150	mV
$V_{OL}$	Low level output voltage	$R_L = 10k\Omega$ $R_L = 600\Omega$	-	15 45	40 150	mV
$I_{out}$	$I_{sink}$	$V_o = 3.3V$ , $T = 25^\circ C$ $T_{min} < T_{amb} < T_{max}$	18 16	32 -	-	mA
	$I_{source}$	$V_o = 0V$ , $T = 25^\circ C$ $T_{min} < T_{amb} < T_{max}$	18 16	35 -	-	
$I_{CC}$	Supply current (per operator)	No load, $V_{out}=V_{CC}/2$	-	0.8	1.1	mA
<b>AC performance</b>						
GBP	Gain bandwidth product	$R_L = 2k\Omega$ , $C_L = 100pF$ , $f = 100kHz$ , $T = 25^\circ C$	-	20	-	MHz
$\phi_m$	Phase margin	$R_L = 2k\Omega$ , $C_L = 100pF$ , $G=5$ , $T = 25^\circ C$	-	60	-	Degrees
$G_m$	Gain margin	$R_L = 2k\Omega$ , $C_L = 100pF$ , $f = 100kHz$ , $\phi_m=40^\circ$ , $T = 25^\circ C$	-	2.5	-	dB
SR	Slew rate	$R_L = 2k\Omega$ , $C_L = 100pF$ , $f = 100kHz$ , $T = 25^\circ C$	-	10	-	V/ $\mu$ s
$e_n$	Equivalent input noise voltage	$f=10kHz$ , $T = 25^\circ C$	-	21	-	$\frac{nV}{\sqrt{Hz}}$
THD+ $e_n$	Total harmonic distortion	$G=1$ , $f=1kHz$ , $R_L=2k\Omega$ , $Bw=22kHz$ , $V_{icm}=(V_{CC}+1)/2$ , $V_{out}=1.9V_{pp}$ , $T=25^\circ C$	-	0.001	-	%

1. All parameter limits at temperatures other than  $25^\circ C$  are guaranteed by correlation.

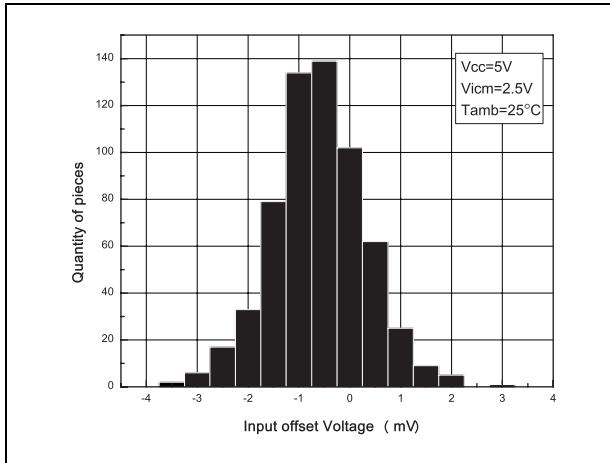
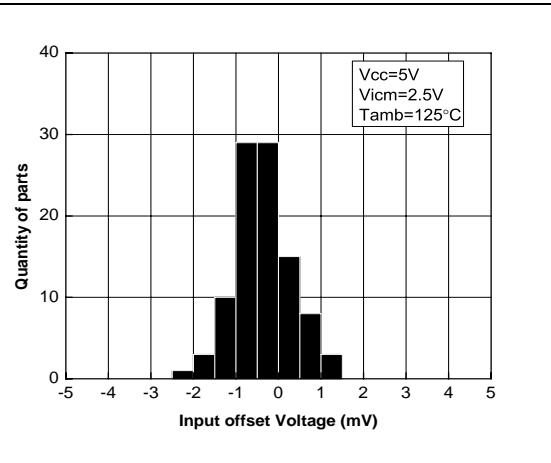
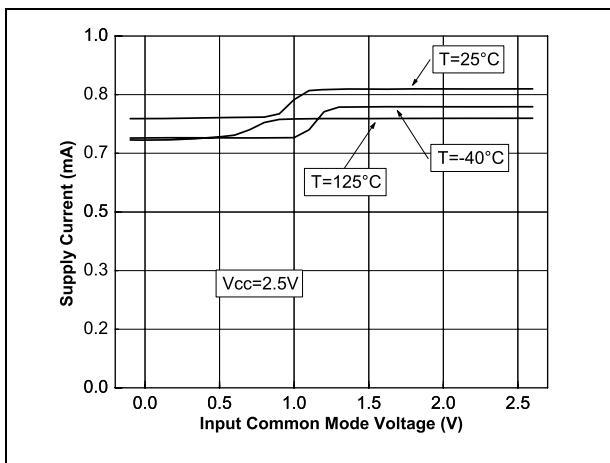
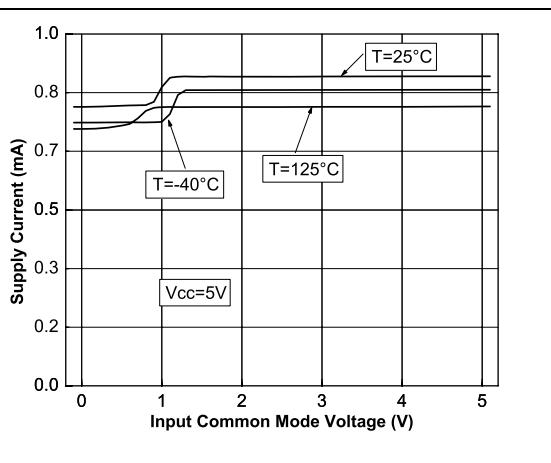
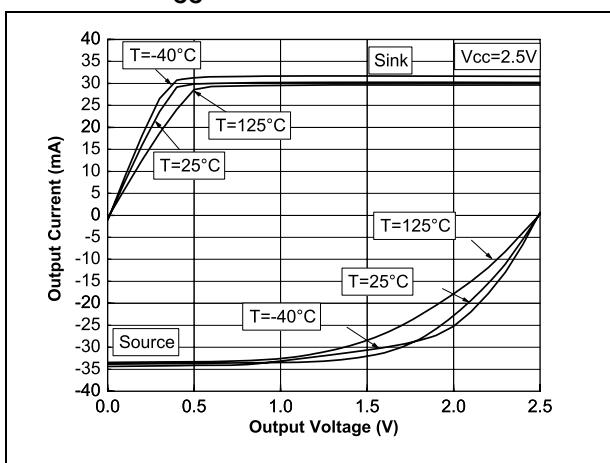
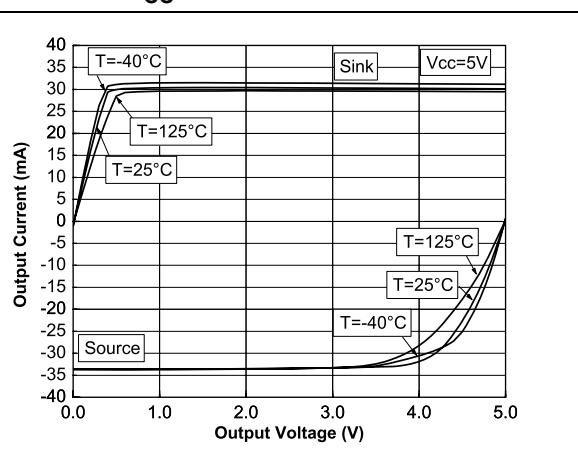
2. Guaranteed by design.

**Table 5. Electrical characteristics at  $V_{CC} = +5V$ ,  $V_{DD} = 0V$ ,  $V_{icm} = V_{CC}/2$ ,  $R_L$  connected to  $V_{CC}/2$ , full temperature range (unless otherwise specified)<sup>(1)</sup>**

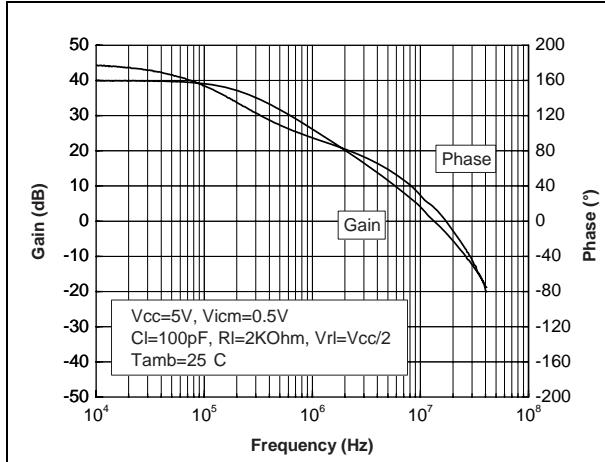
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>DC performance</b>						
$V_{io}$	Offset voltage TSV99x	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	0.1	4.5	mV
	TSV99xA	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	-	1.5	
$DV_{io}$	Input offset voltage drift		-	2	-	$\mu V/^\circ C$
$I_{io}$	Input offset current <sup>(2)</sup> ( $V_{out} = V_{CC}/2$ )	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	1	10	pA
$I_{ib}$	Input bias current <sup>(2)</sup> ( $V_{out} = V_{CC}/2$ )	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	1	10	pA
CMR	Common mode rejection ratio $20 \log (\Delta V_{ic}/\Delta V_{io})$	0V to 5V, $V_{out} = 2.5V$	62	82	-	dB
SVR	Supply voltage rejection ratio $20 \log (\Delta V_{cc}/\Delta V_{io})$	$V_{CC} = 2.5$ to 5V	70	86	-	dB
$A_{vd}$	Large signal voltage gain	$R_L=10k\Omega$ , $V_{out}= 0.5V$ to 4.5V, $T=25^\circ C$ $T_{min} < T_{op} < T_{max}$	80	91	-	dB
			75	-	-	dB
$V_{CC}-V_{OH}$	High level output voltage	$R_L = 10k\Omega$ $R_L = 600\Omega$		15 45	40 150	mV
$V_{OL}$	Low level output voltage	$R_L = 10k\Omega$ $R_L = 600\Omega$	-	15 45	40 150	mV
$I_{out}$	$I_{sink}$	$V_o = 5V$ , $T = 25^\circ C$ $T_{min} < T_{amb} < T_{max}$	18 16	32 -	-	mA
	$I_{source}$	$V_o = 0V$ , $T = 25^\circ C$ $T_{min} < T_{amb} < T_{max}$	18 16	35 -	-	
$I_{CC}$	Supply current (per operator)	No load, $V_{out}=2.5V$	-	0.82	1.1	mA
<b>AC performance</b>						
GBP	Gain bandwidth product	$R_L = 2k\Omega$ , $C_L = 100pF$ , $f = 100kHz$ , $T = 25^\circ C$	-	20	-	MHz
$\phi_m$	Phase margin	$R_L = 2k\Omega$ , $C_L = 100pF$ , $G=5$ , $T = 25^\circ C$	-	60	-	Degrees
$G_m$	Gain margin	$R_L = 2k\Omega$ , $C_L = 100pF$ , $\phi_m=40^\circ$ , $T = 25^\circ C$	-	2.5	-	dB
SR	Slew rate	$R_L = 2k\Omega$ , $C_L = 100pF$ , $T = 25^\circ C$	-	10	-	V/ $\mu$ s
$e_n$	Equivalent input noise voltage	$f=10kHz$ , $T=25^\circ C$	-	21	-	$\frac{nV}{\sqrt{Hz}}$
THD+ $e_n$	Total harmonic distortion	$G=1$ , $f=1kHz$ , $R_L=2k\Omega$ , $Bw=22kHz$ , $V_{icm}=(V_{CC}+1)/2$ , $V_{out}=3.6V_{pp}$ , $T=25^\circ C$	-	0.0007	-	%

1. All parameter limits at temperatures other than  $25^\circ C$  are guaranteed by correlation.

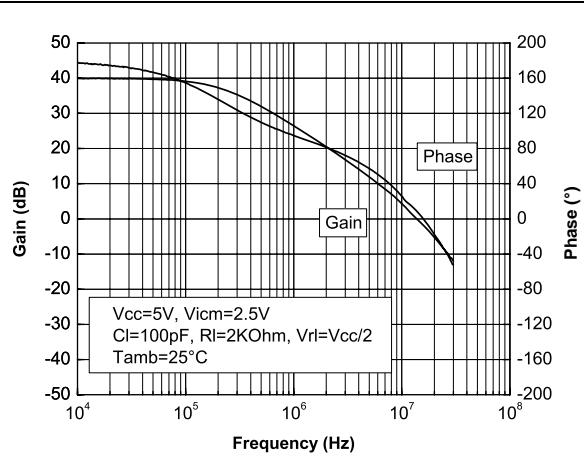
2. Guaranteed by design.

**Figure 1. Input offset voltage distribution at  $T = 25^\circ\text{C}$** **Figure 2. Input offset voltage distribution at  $T = 125^\circ\text{C}$** **Figure 3. Supply current vs. input common mode voltage at  $V_{CC} = 2.5\text{V}$** **Figure 4. Supply current vs. input common mode voltage at  $V_{CC} = 5\text{V}$** **Figure 5. Output current vs. output voltage at  $V_{CC} = 2.5\text{V}$** **Figure 6. Output current vs. output voltage at  $V_{CC} = 5\text{V}$** 

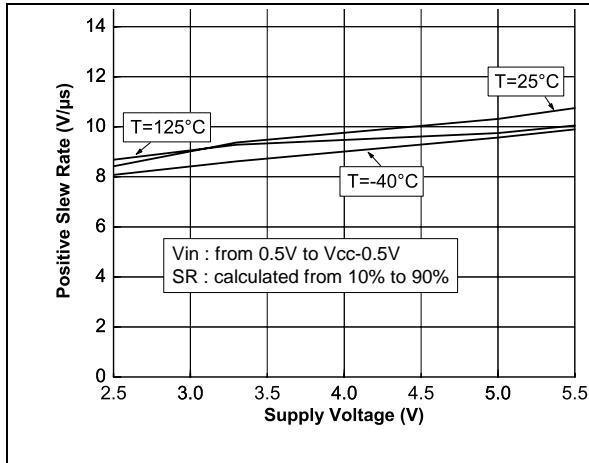
**Figure 7. Voltage gain and phase vs frequency at  $V_{CC}=5V$  and  $V_{icm}=0.5V$**



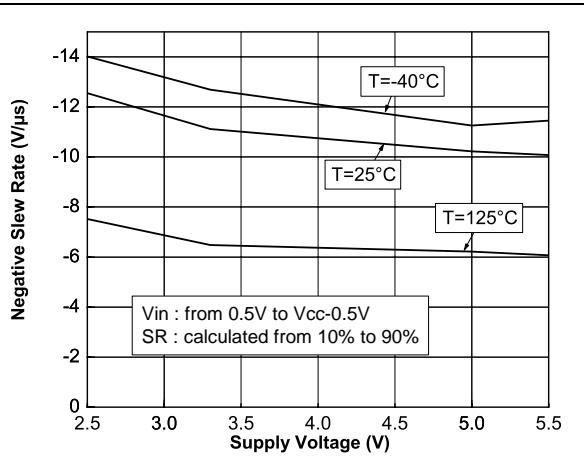
**Figure 8. Voltage gain and phase vs frequency at  $V_{CC}=5V$  and  $V_{icm}=2.5V$**



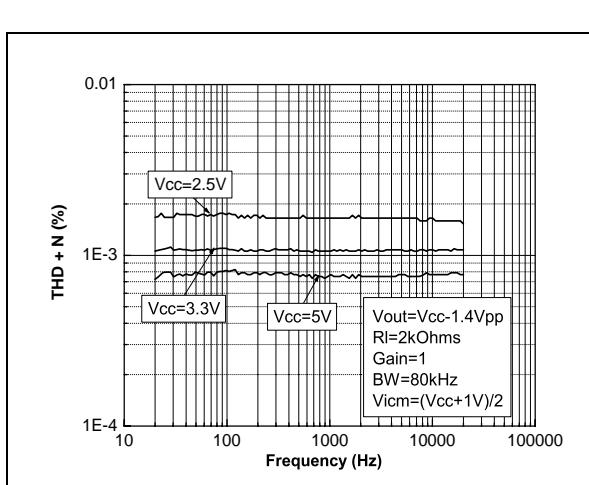
**Figure 9. Positive slew rate**



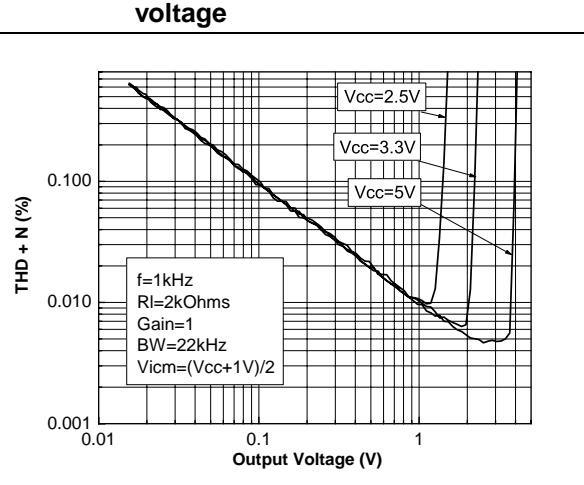
**Figure 10. Negative slew rate**

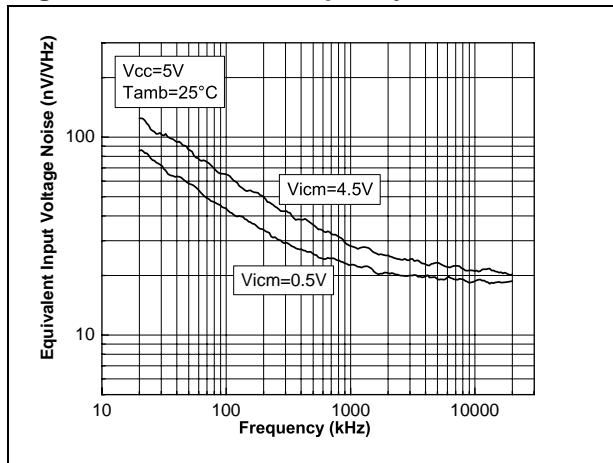


**Figure 11. Distortion + noise vs. frequency**



**Figure 12. Distortion + noise vs. output voltage**



**Figure 13. Noise vs. frequency**

### 3 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

*Note:* All packages are Moisture Sensitivity Level 1 as per Jedec J-STD-020-C, except SO-14 which is Jedec level 3.

### 3.1 SOT23-5 package information

Figure 14. SOT23-5 package mechanical drawing

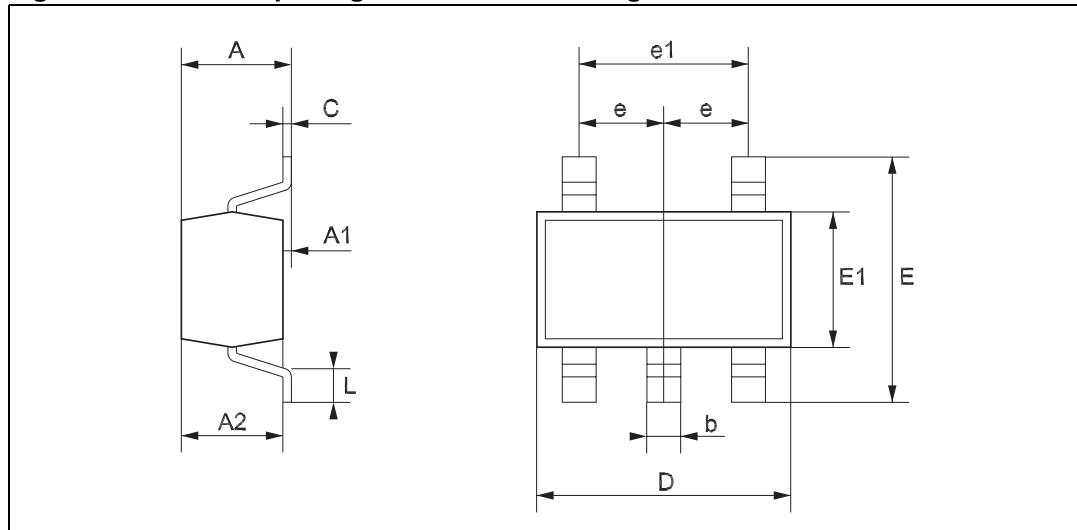
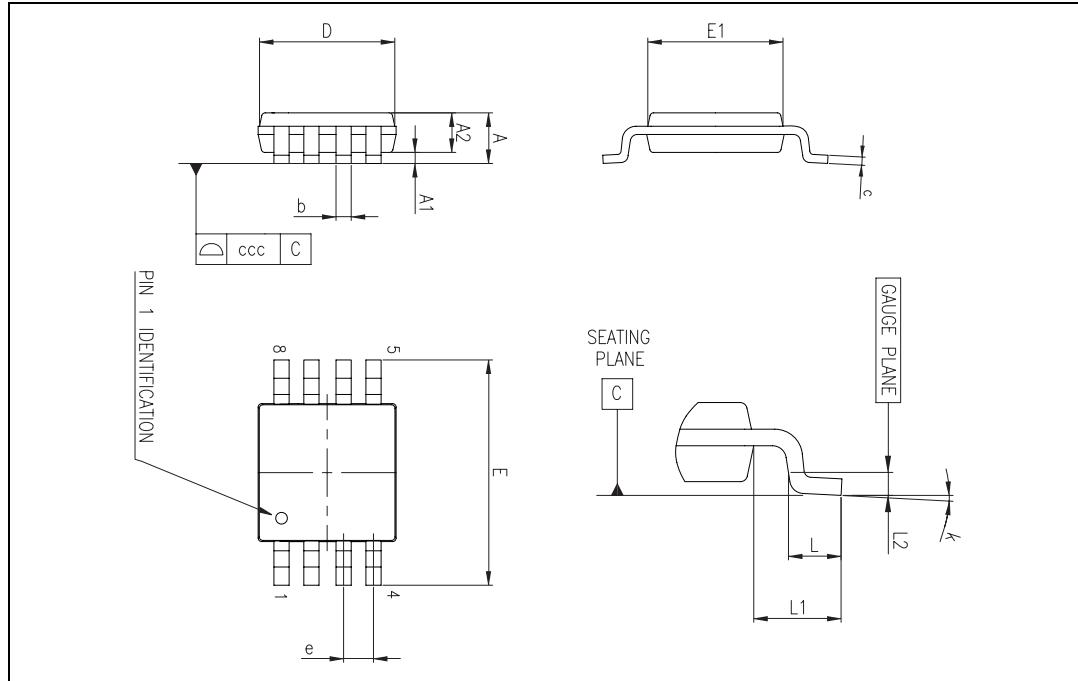


Table 6. SOT23-5 package mechanical data

Ref.	Dimensions					
	Millimeters			Mils		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.45	35.4		57.1
A1	0.00		0.15	0.00		5.9
A2	0.90		1.30	35.4		51.2
b	0.35		0.50	13.7		19.7
C	0.09		0.20	3.5		7.8
D	2.80		3.00	110.2		118.1
E	2.60		3.00	102.3		118.1
E1	1.50		1.75	59.0		68.8
e		0.95			37.4	
e1		1.9			74.8	
L	0.35		0.55	13.7		21.6

### 3.2 MiniSO-8 package information

**Figure 15.** MiniSO-8 package mechanical drawing



**Table 7.** MiniSO-8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.1			0.043
A1	0		0.15	0		0.006
A2	0.75	0.85	0.95	0.030	0.033	0.037
b	0.22		0.40	0.009		0.016
c	0.08		0.23	0.003		0.009
D	2.80	3.00	3.20	0.11	0.118	0.126
E	4.65	4.90	5.15	0.183	0.193	0.203
E1	2.80	3.00	3.10	0.11	0.118	0.122
e		0.65			0.026	
L	0.40	0.60	0.80	0.016	0.024	0.031
L1		0.95			0.037	
L2		0.25			0.010	
k	0°		8°	0°		8°
ccc			0.10			0.004

Figure 16. SO-8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
A1	0.10		0.25	0.004		0.010
A2	1.25			0.049		
b	0.28		0.48	0.011		0.019
c	0.17		0.23	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
H	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	1°		8°	1°		8°
ccc			0.10			0.004

The figure contains three detailed mechanical drawings of the SO-8 package:

- Top View:** Shows the package from above with pins numbered 1 through 8. Dimensions include D (width), E1 (height), and e (pin pitch).
- Side View:** Shows the package thickness (A) and lead spacing (b). It also includes a cross-sectional view of the lead tip with a 45° angle and height C.
- Cross-Section:** Shows the internal structure with the seating plane at the bottom. The gage plane is located 0.25 mm above the seating plane. Dimensions include A1, A2, L, L1, and k.

### 3.3 TSSOP14 package information

Figure 17. TSSOP14 package mechanical drawing

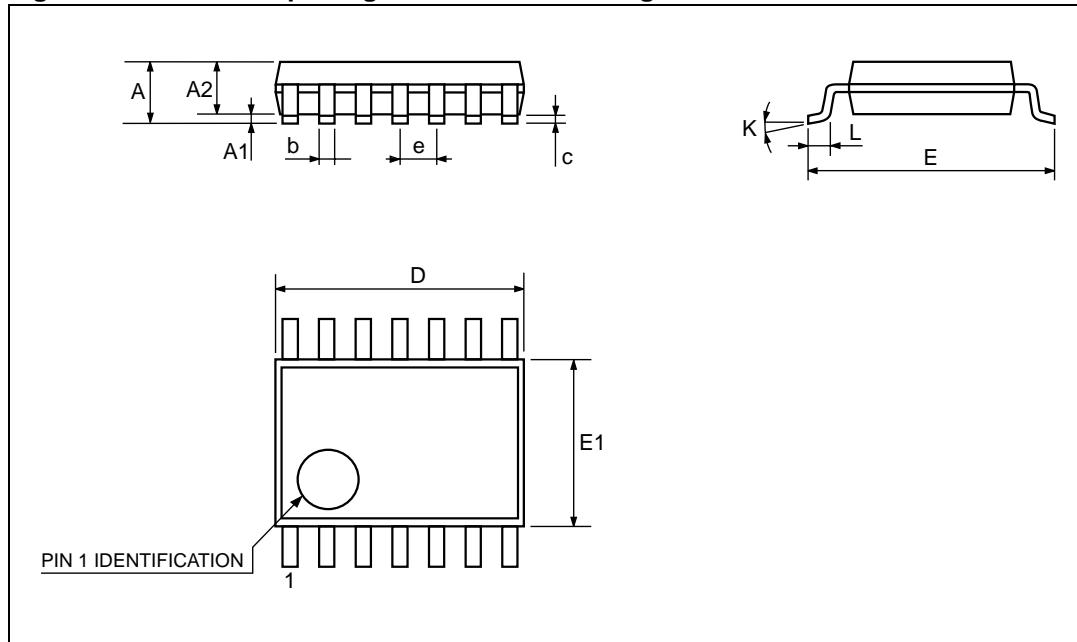
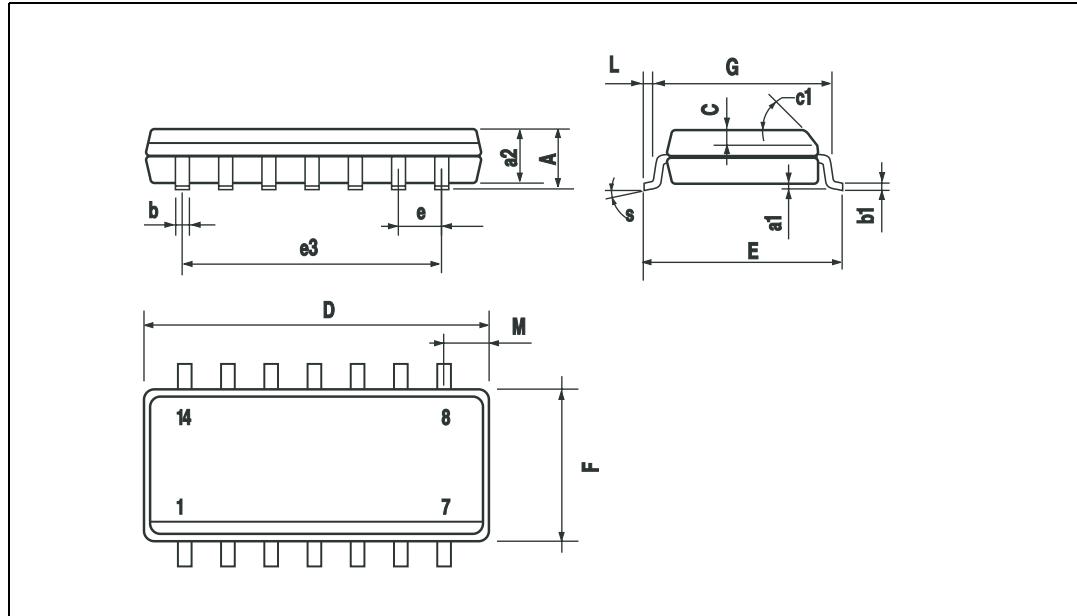


Table 8. TSSOP14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L1	0.45	0.60	0.75	0.018	0.024	0.030

### 3.4 SO-14 package information

Figure 18. SO-14 package mechanical drawing



## 4 Ordering information

**Table 9. Order codes<sup>(1)</sup>**

Order code	Temperature range	Package	Packing	Marking	
TSV991ILT	-40°C to +125°C	SOT23-5	Tape & reel	K130	
TSV991ALT				K129	
TSV992IST		MiniSO-8		K132	
TSV992AIST				K135	
TSV992ID		SO-8	Tube or tape & reel	V992I	
TSV992IDT				V992AI	
TSV992AID			TSSOP14	V994I	
TSV992AIDT				V994AI	
TSV994IPT		SO-14 <sup>(1)</sup>	Tape & reel	V994I	
TSV994AIPT				V994AI	
TSV994ID			Tube or tape & reel	V994I	
TSV994IDT				V994AI	
TSV994AID		SO-8 Automotive grade	Tube or tape & reel	V991IY	
TSV994AIDT				V991AY	
TSV991IYD <sup>(2)</sup>				V992IY	
TSV991IYDT <sup>(2)</sup>				V992AY	
TSV991AIYD <sup>(2)</sup>			SO-14 <sup>(1)</sup> Automotive grade	V994IY	
TSV991AIYDT <sup>(2)</sup>				V994AY	
TSV992IYD <sup>(2)</sup>					
TSV992IYDT <sup>(2)</sup>					
TSV992AIYD <sup>(2)</sup>					
TSV992AIYDT <sup>(2)</sup>					
TSV994IYD <sup>(2)</sup>					
TSV994IYDT <sup>(2)</sup>					
TSV994AIYD <sup>(2)</sup>					
TSV994AIYDT <sup>(2)</sup>					

1. All packages are Moisture Sensitivity Level 1 as per Jedec J-STD-020-C, except SO-14 which is Jedec level 3.
2. Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q 002 or equivalent are on-going.

## 5 Revision history

Date	Revision	Changes
31-Jul-2006	1	Preliminary data release for product under development.
07-Nov-2006	2	Final version of datasheet.
12-Dec-2006	3	Noise and distortion figures added.
07-Jun-2007	4	ESD tolerance modified for SO-14, CDM in <a href="#">Table 1: Absolute maximum ratings (AMR)</a> . Automotive grade commercial products added in <a href="#">Table 9: Order codes</a> . Note about SO-14 added in <a href="#">Table 9: Order codes</a> . Limits in temperature added in <a href="#">Section 2: Electrical characteristics</a> .
11-Feb-2008	5	Corrected MiniSO-8 package information. Corrected footnote for automotive grade order codes in order code table. Improved presentation of package information.

**Please Read Carefully:**

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

**UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.**

**UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.**

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2008 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -  
Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

[www.st.com](http://www.st.com)